

Title (en)
METHOD FOR PRODUCING ELECTRICAL CONTACTS ON A COMPONENT

Title (de)
VERFAHREN ZUR HERSTELLUNG ELEKTRISCHER KONTAKTE AUF EINEM BAUTEIL

Title (fr)
PROCÉDÉ POUR ÉTABLIR DES CONTACTS ÉLECTRIQUES SUR UN COMPOSANT

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Application
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Abstract (en)
[origin: WO2018050629A1] The present invention relates to a method for producing one or more electrical contacts on a component, comprising the following steps: - providing a component which has a front and a rear, an outer layer of a transparent, electrically conductive oxide (TCO) or a self-passivating metal or semiconductor being present on the front and/or rear; - applying a structured, electrically conductive seed layer, the application of the seed layer taking place non-galvanically; - galvanically depositing at least one metal on the seed layer.

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Citation (examination)
• US 5933758 A 19990803 - JAIN AJAY [US]
• MARKUS GLATTHAAR ET AL: "METALIZATION - PLATING AND OTHER", HERCULES WORKSHOP, 27 March 2015 (2015-03-27), Konstanz, pages 1 - 18, XP055726414, Retrieved from the Internet <URL:https://www.helmholtz-berlin.de/media/media/projekte/hercules/HERCULES_M18_Workshop/0203_glatthaar_hercules_workshop.pdf> [retrieved on 20200901]
• See also references of WO 2018050629A1

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